

FIG. 1

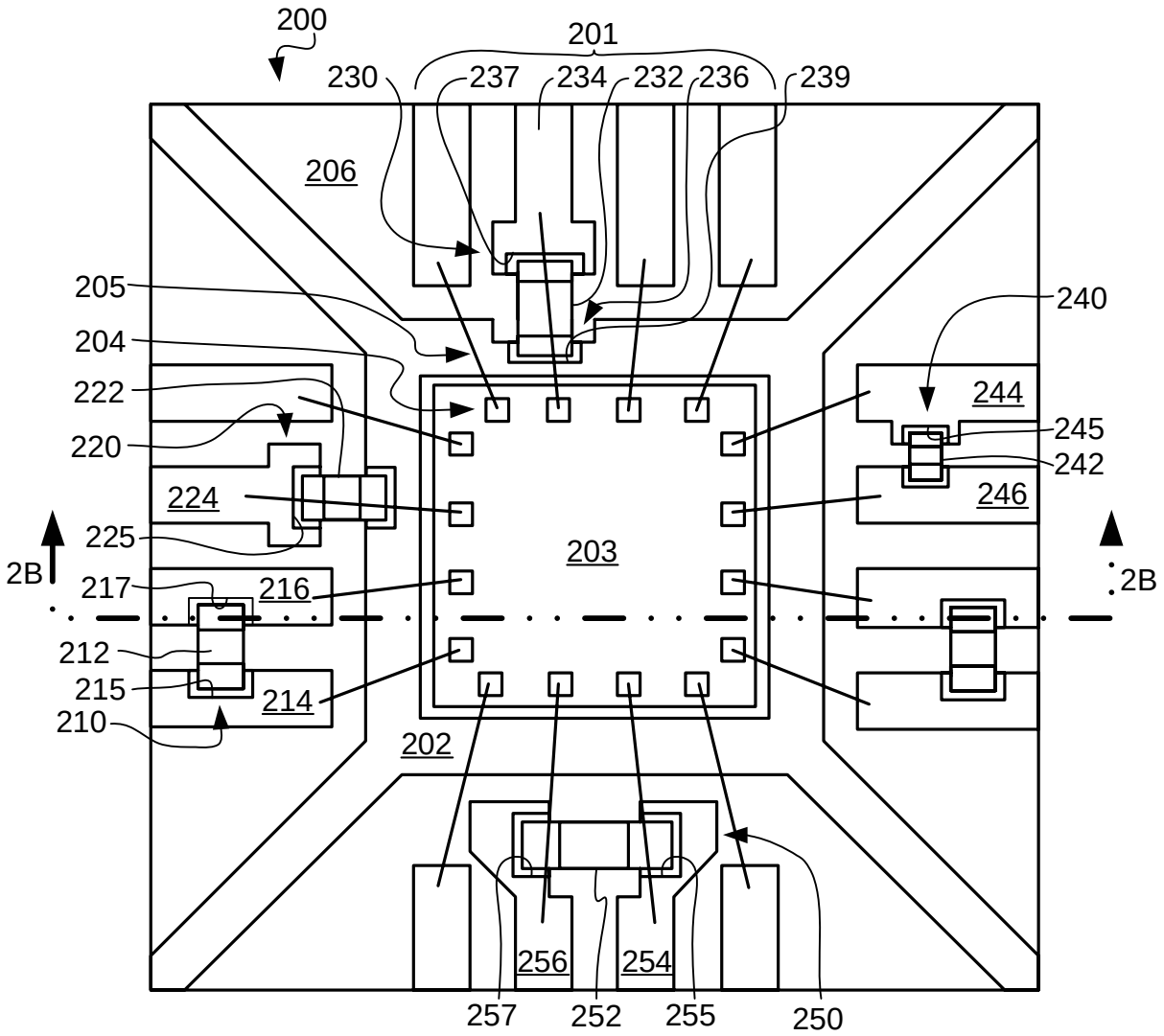
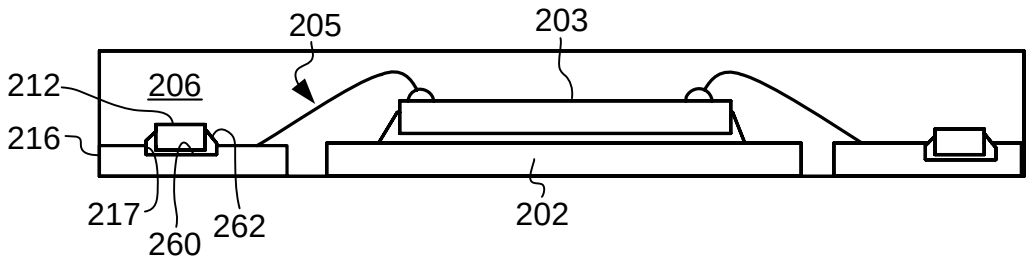


FIG. 2A

FIG. 2B



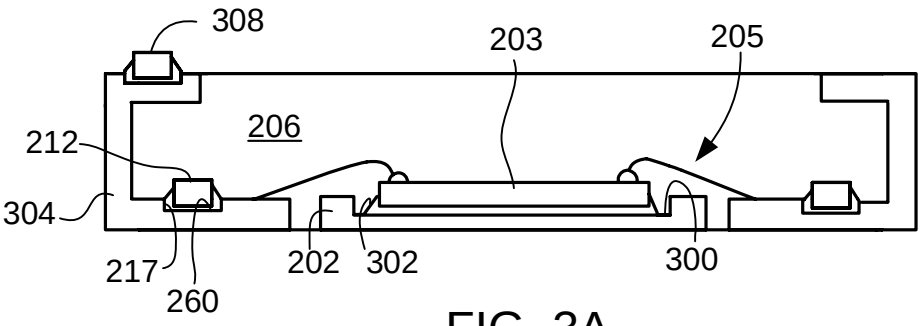


FIG. 3A

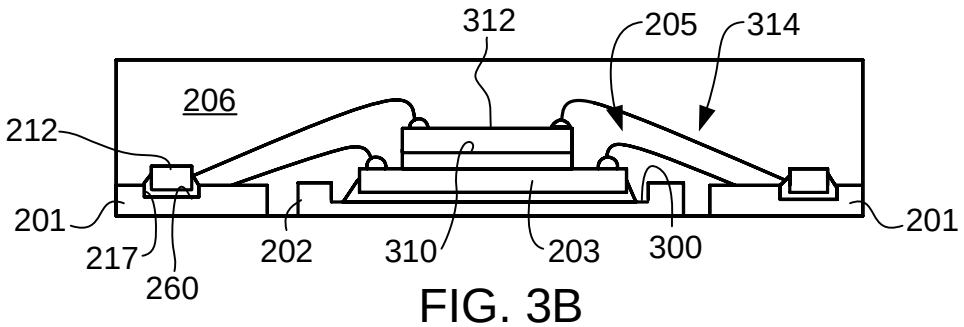


FIG. 3B

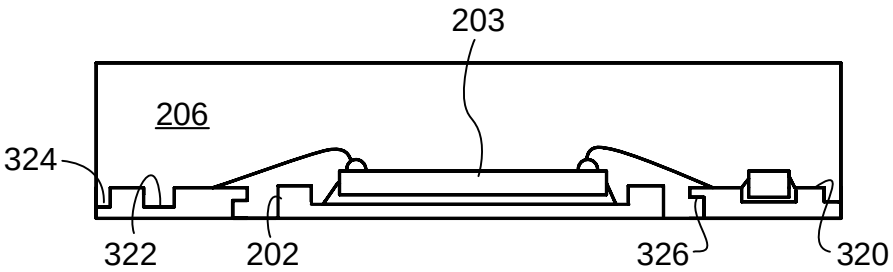


FIG. 3C

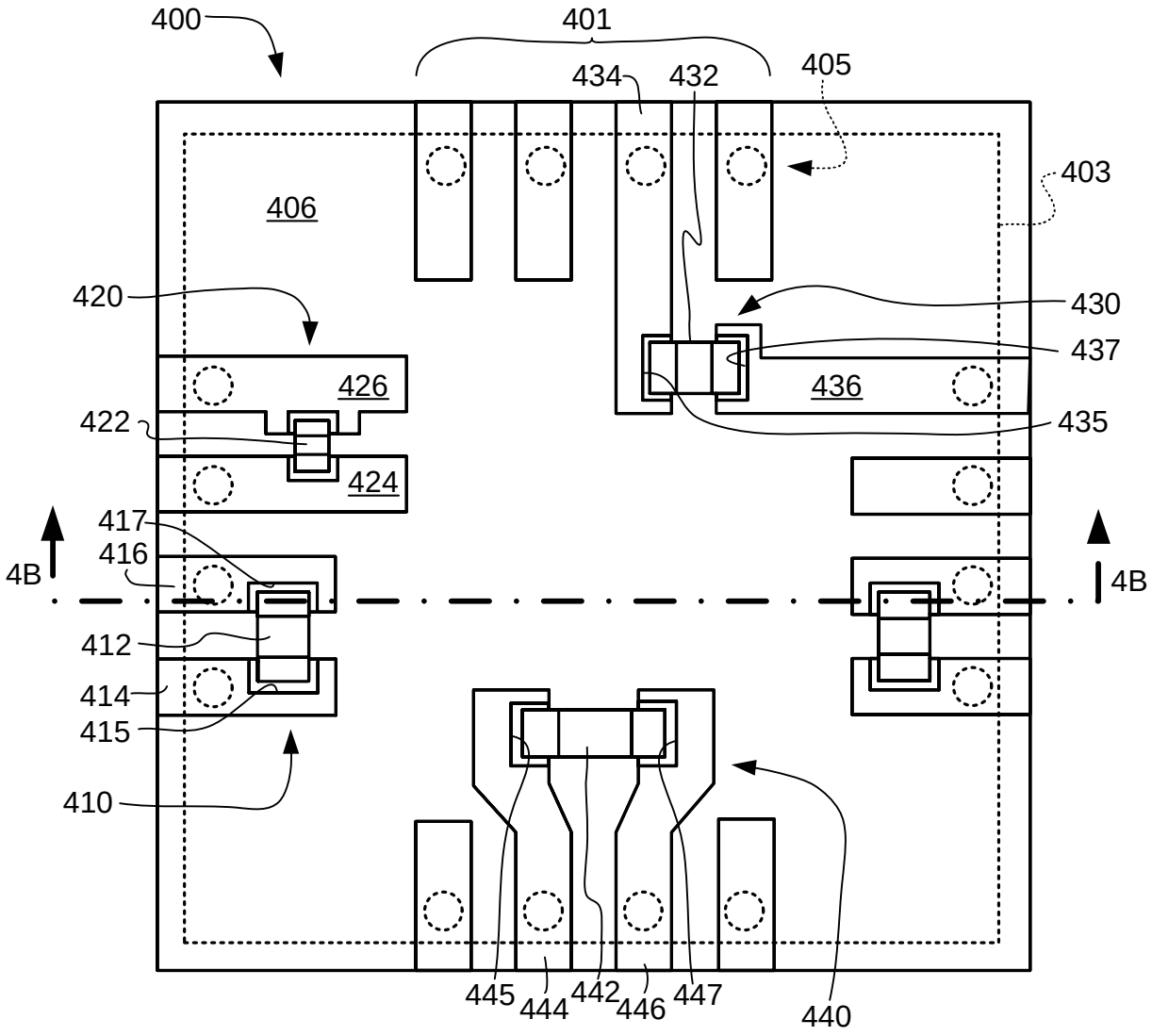
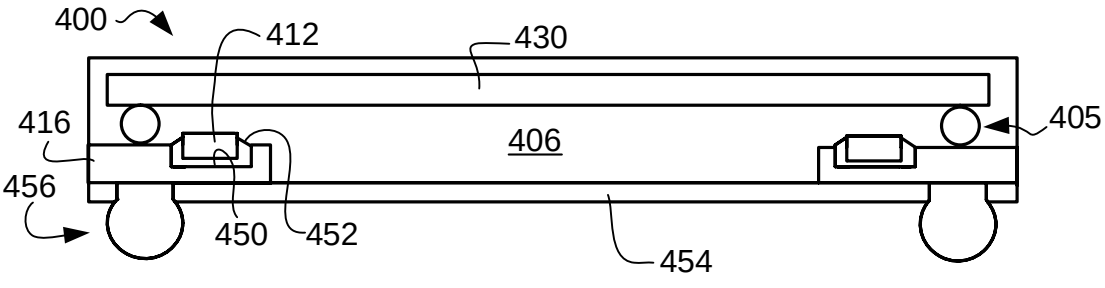

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FIG. 4A

FIG. 4B


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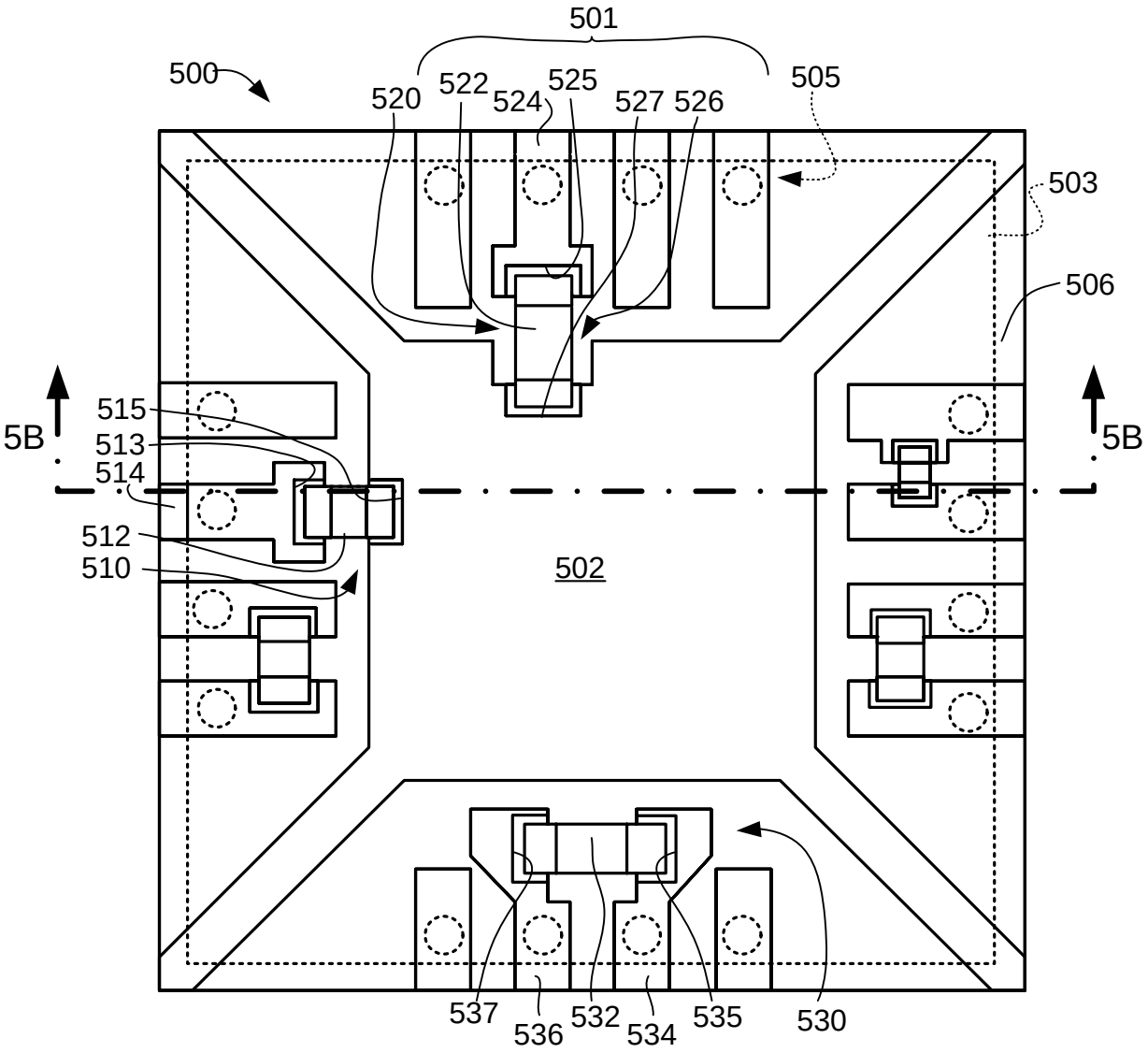
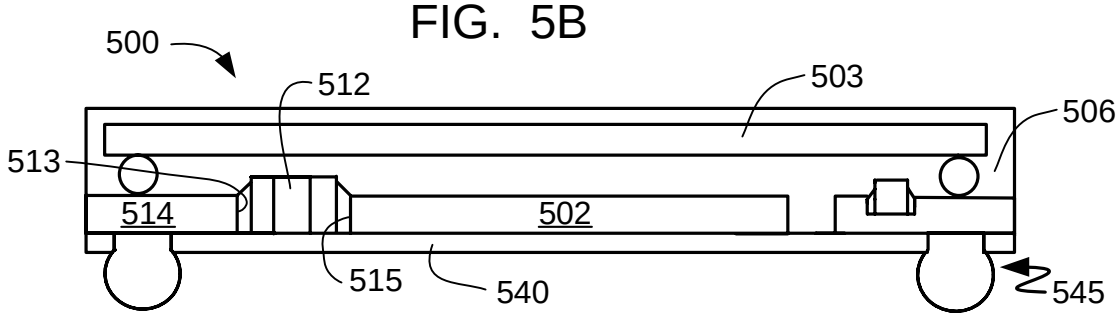

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FIG. 5A

FIG. 5B


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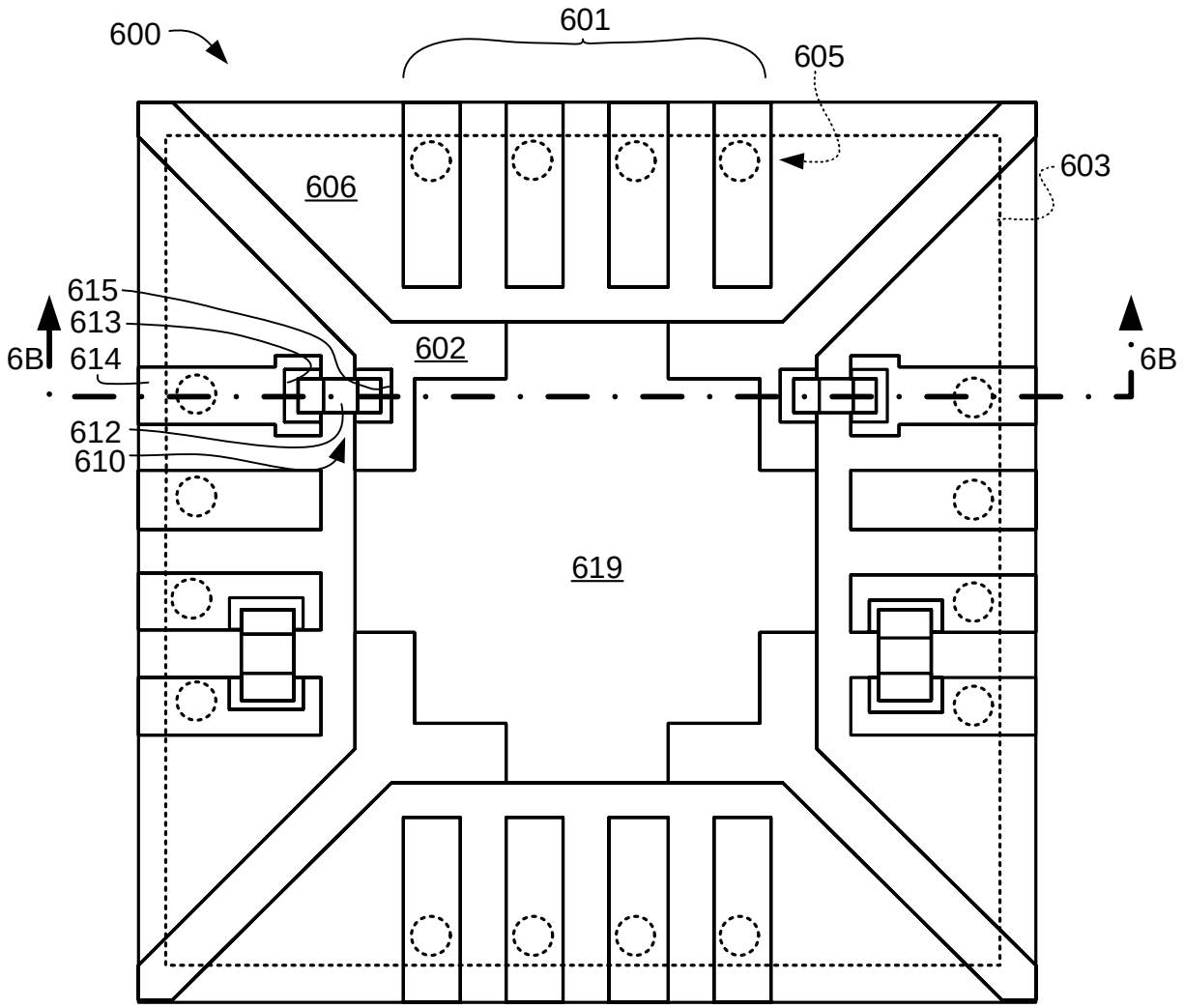
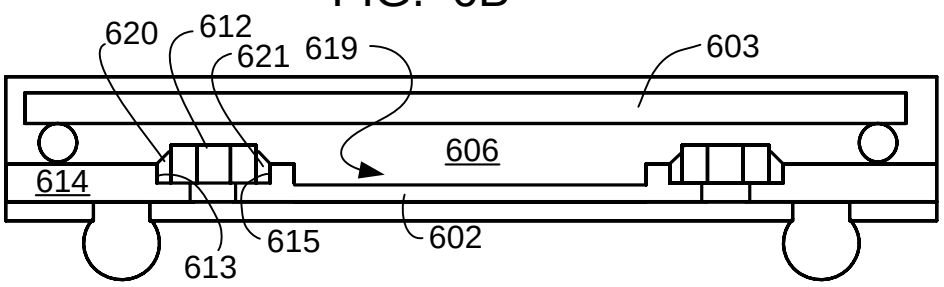

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FIG. 6A

FIG. 6B


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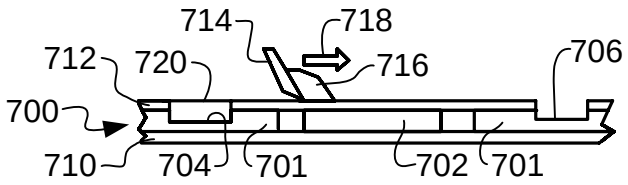


FIG. 7A

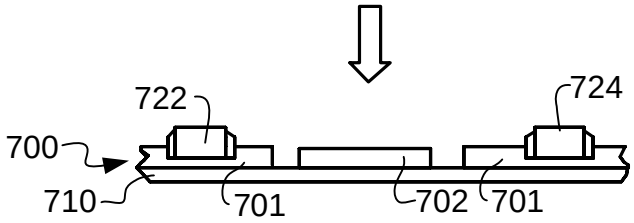


FIG. 7B

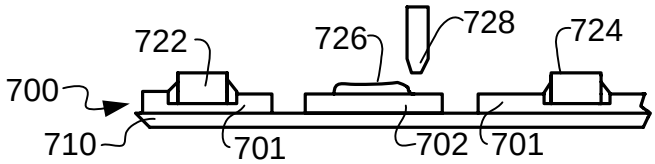


FIG. 7C

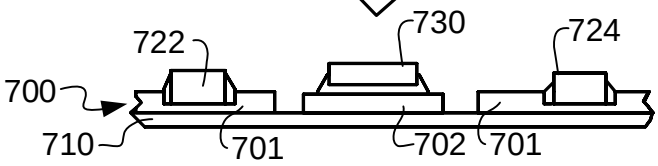


FIG. 7D

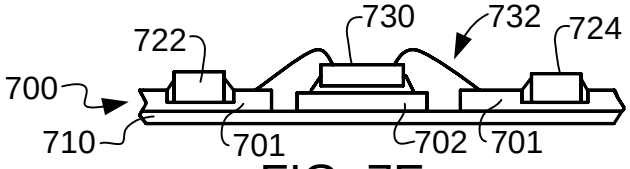


FIG. 7E

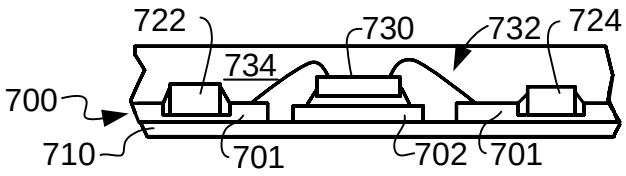


FIG. 7F

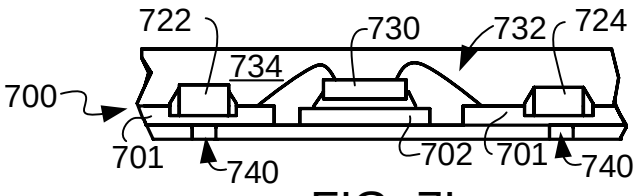


FIG. 7I

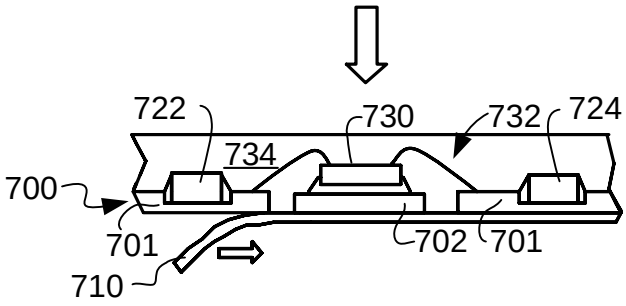


FIG. 7G

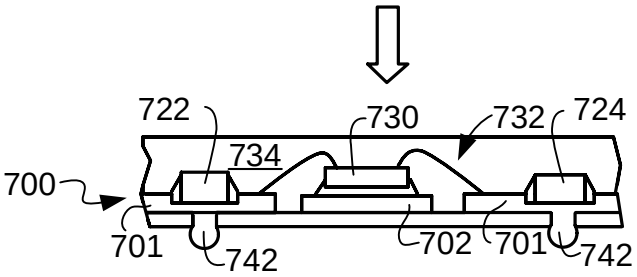


FIG. 7J

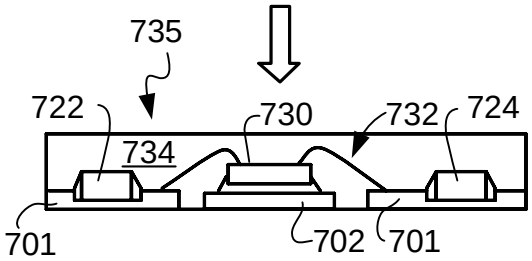


FIG. 7H

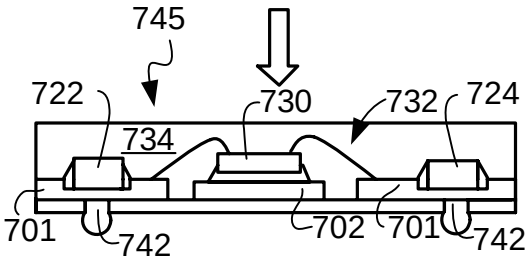


FIG. 7K

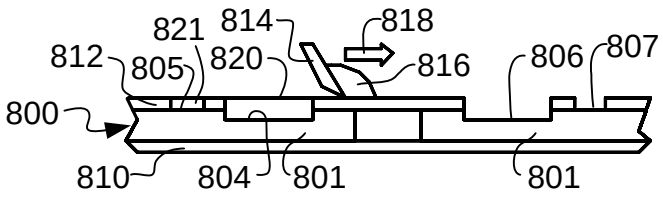


FIG. 8A

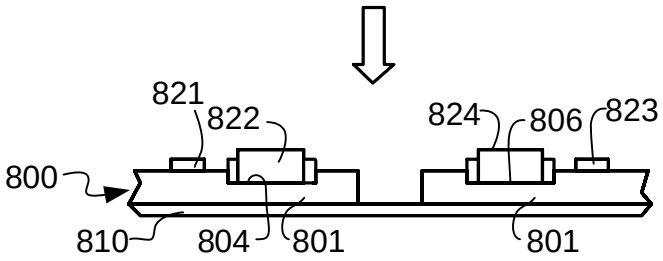


FIG. 8B

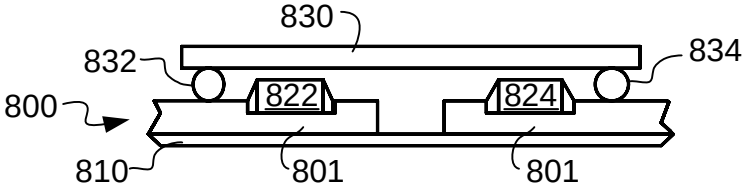


FIG. 8C

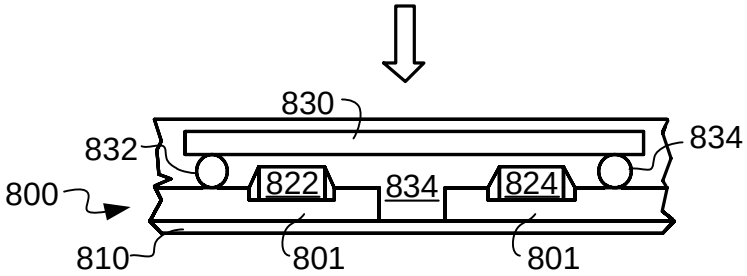


FIG. 8D

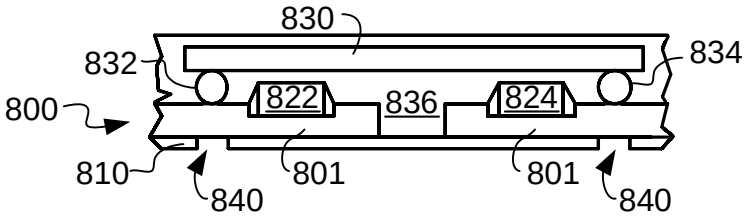


FIG. 8E

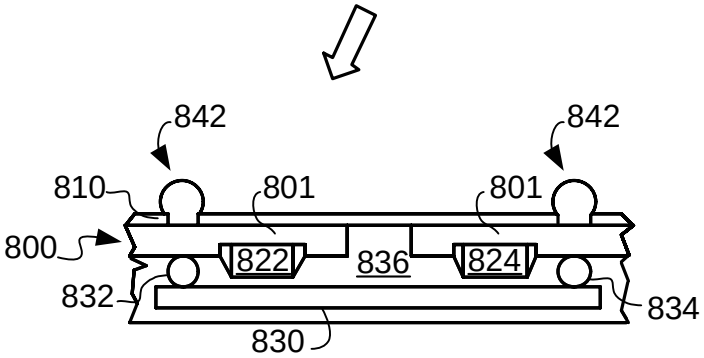


FIG. 8F

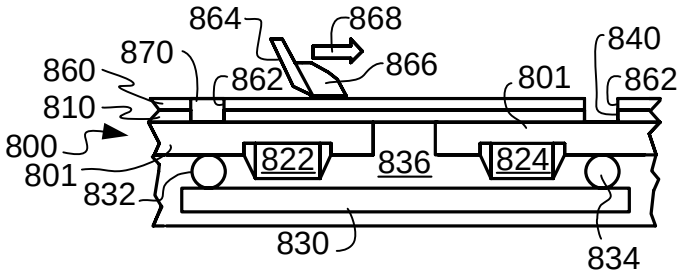


FIG. 8H

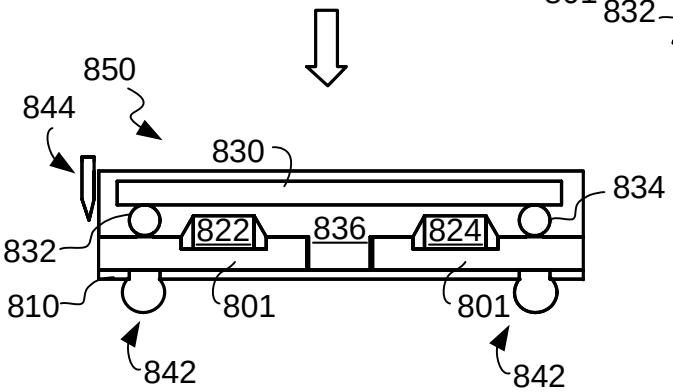


FIG. 8G

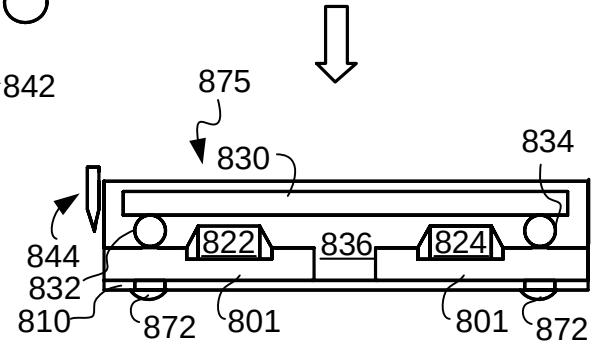


FIG. 8I

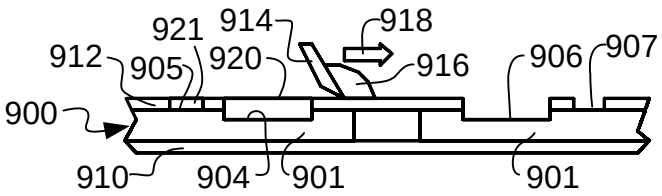


FIG. 9A

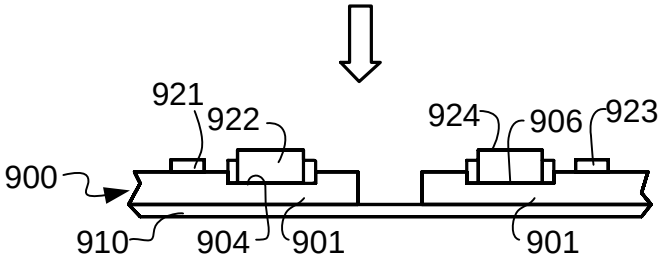


FIG. 9B

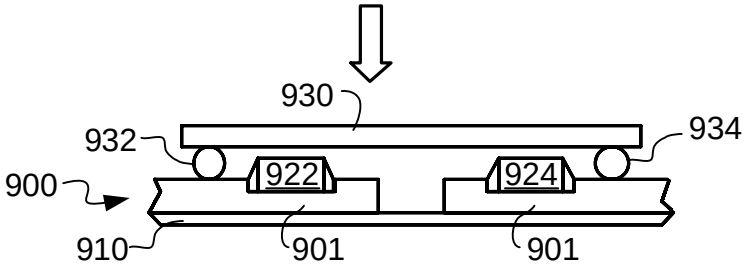


FIG. 9C

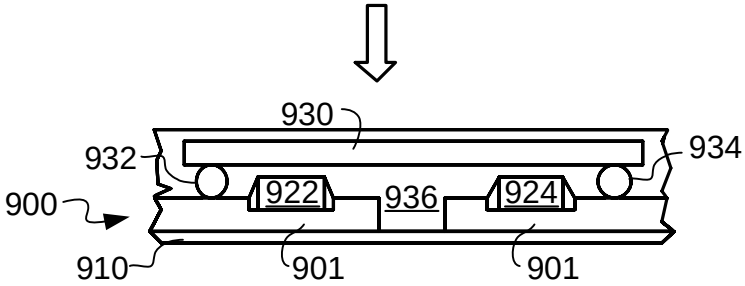


FIG. 9D

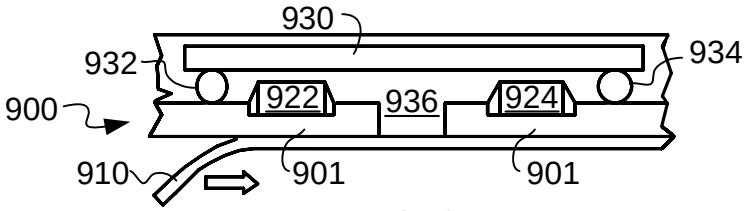


FIG. 9E

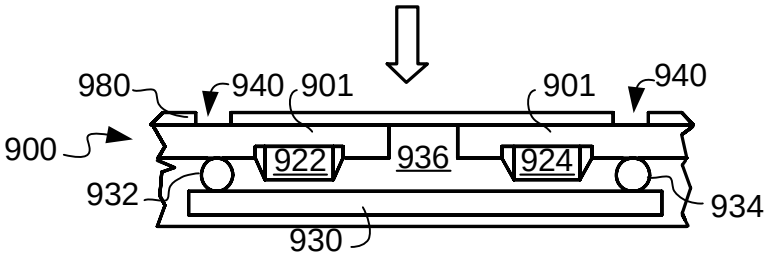


FIG. 9F

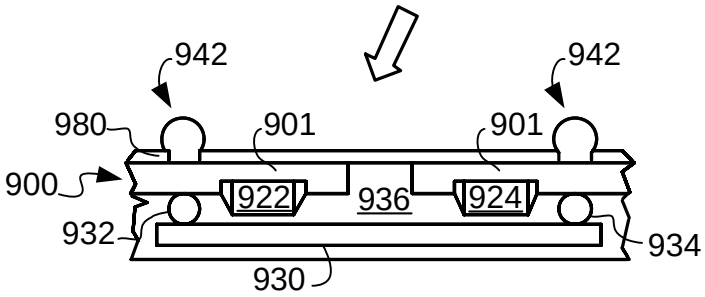


FIG. 9G

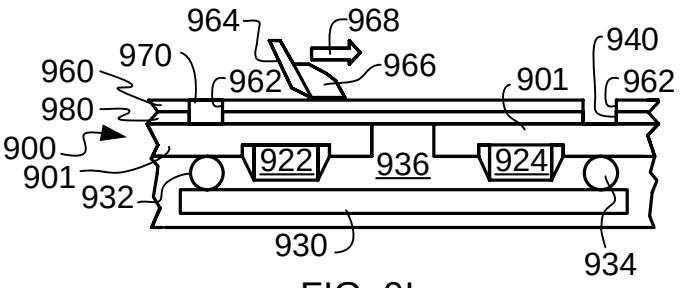


FIG. 9I

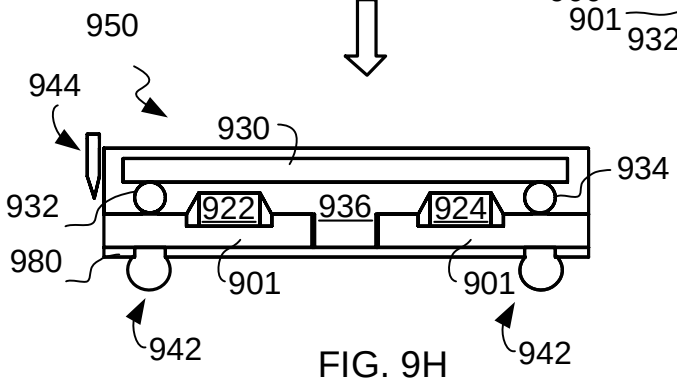


FIG. 9H

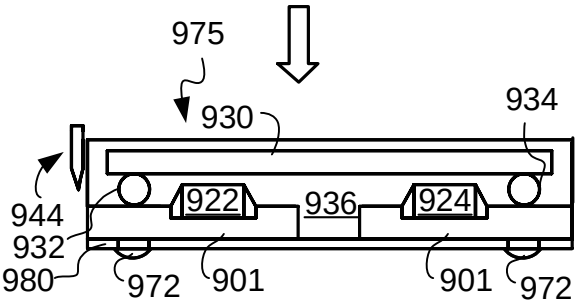


FIG. 9J

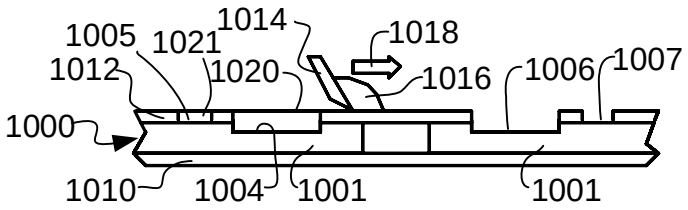


FIG. 10A

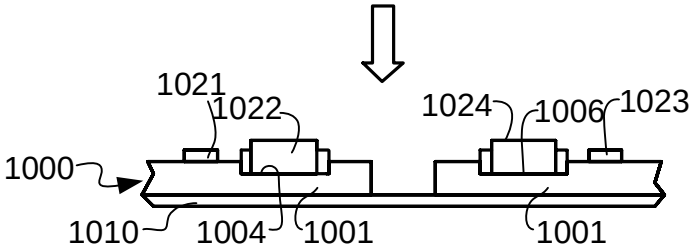


FIG. 10B

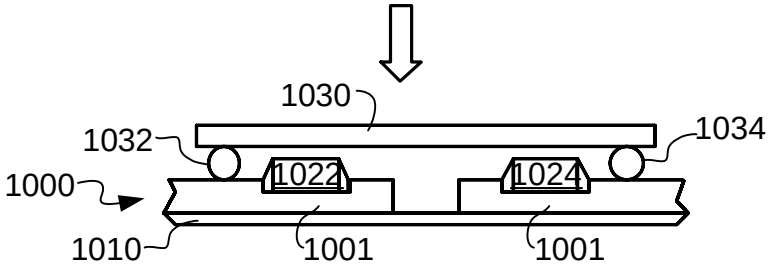


FIG. 10C

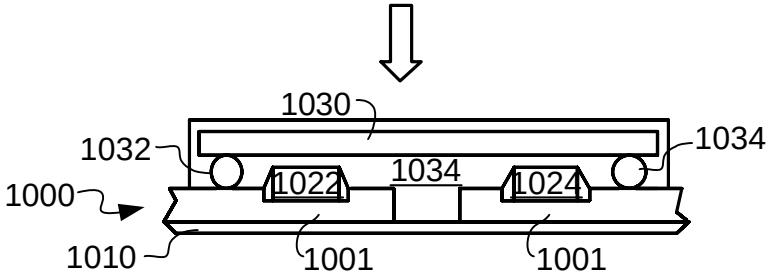


FIG. 10D

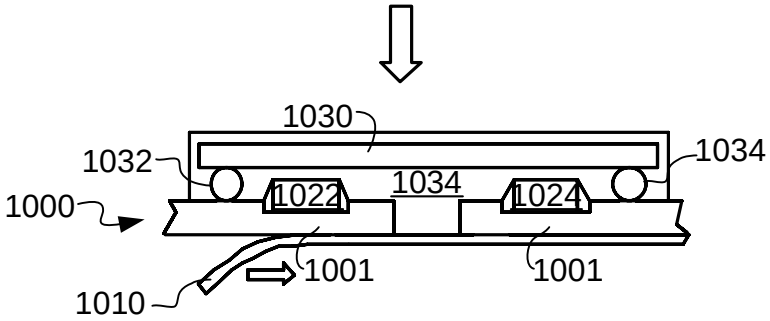


FIG. 10E

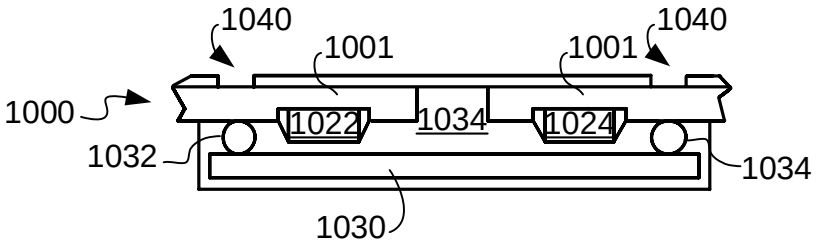


FIG. 10F

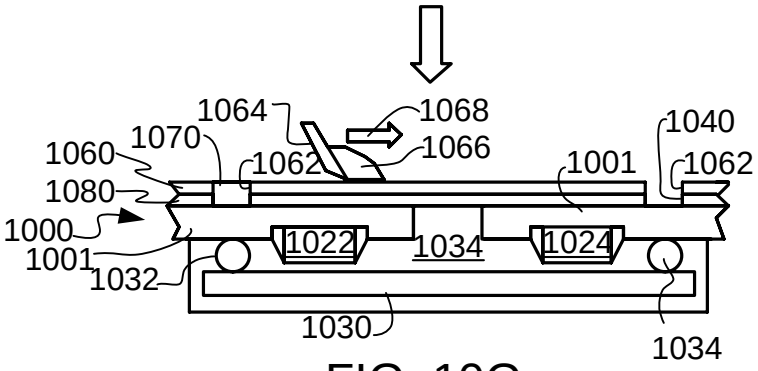


FIG. 10G

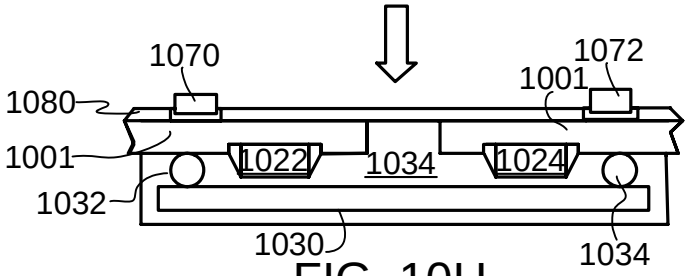


FIG. 10H

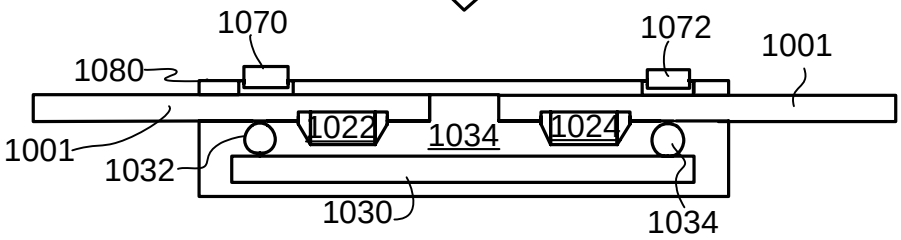


FIG. 10I

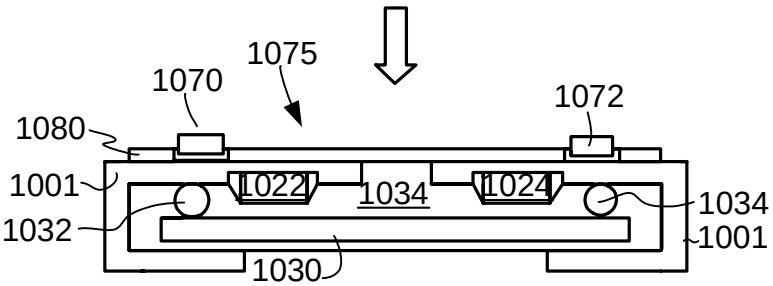


FIG. 10J

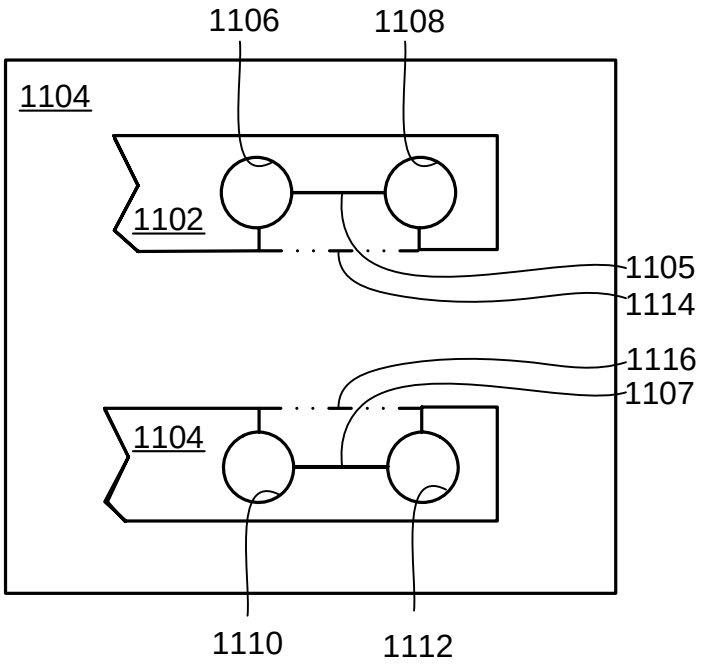


FIG. 11A

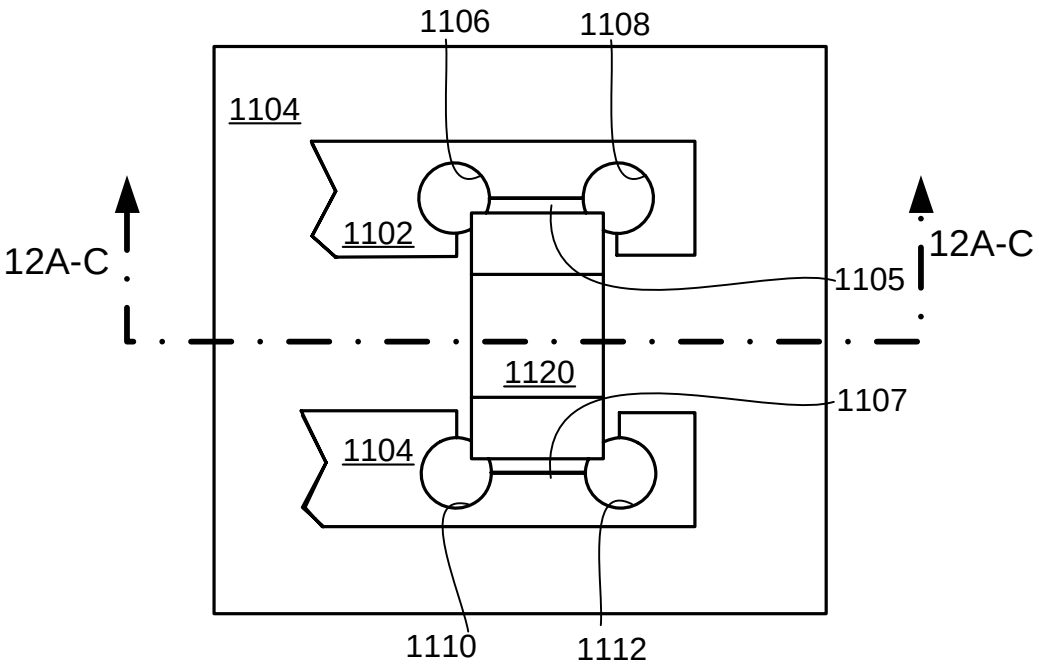


FIG. 11B

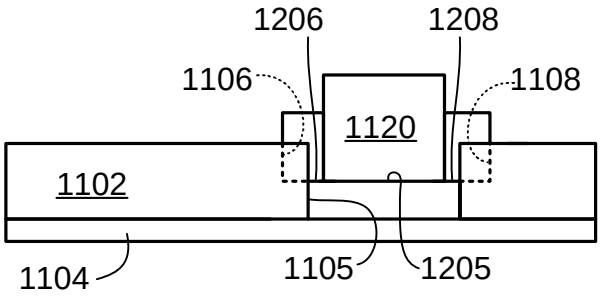


FIG. 12A

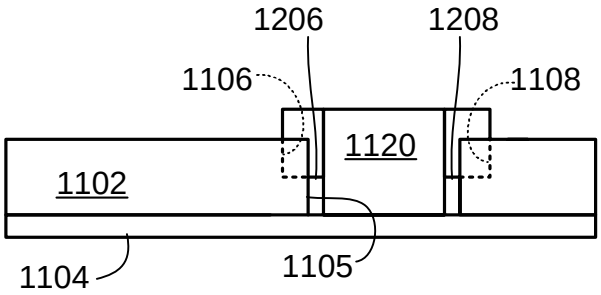


FIG. 12B

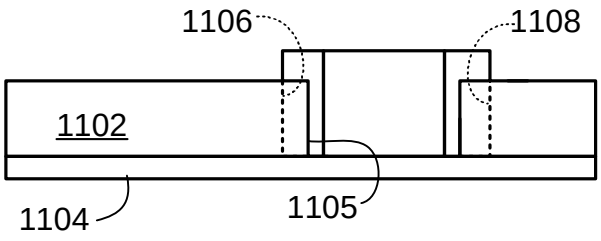


FIG. 12C

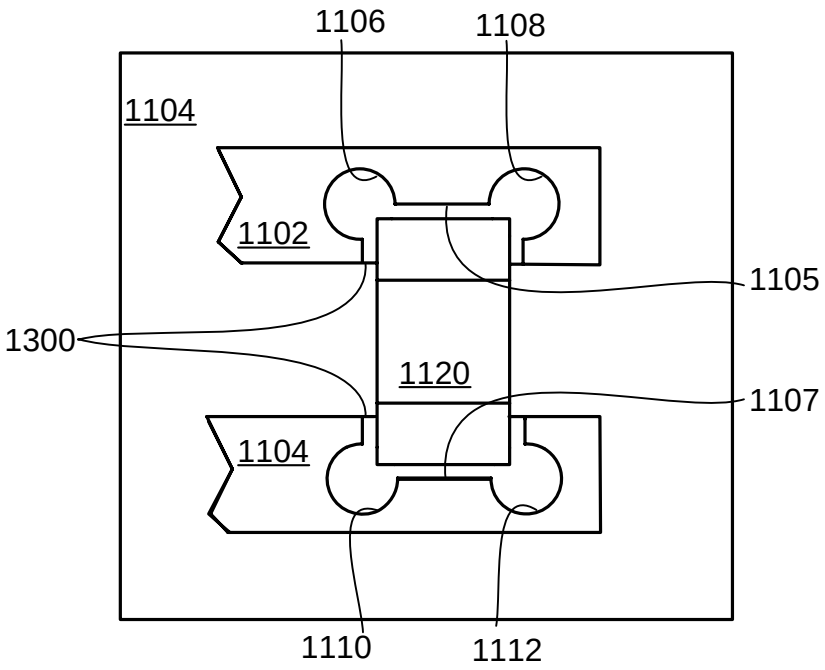

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FIG. 13

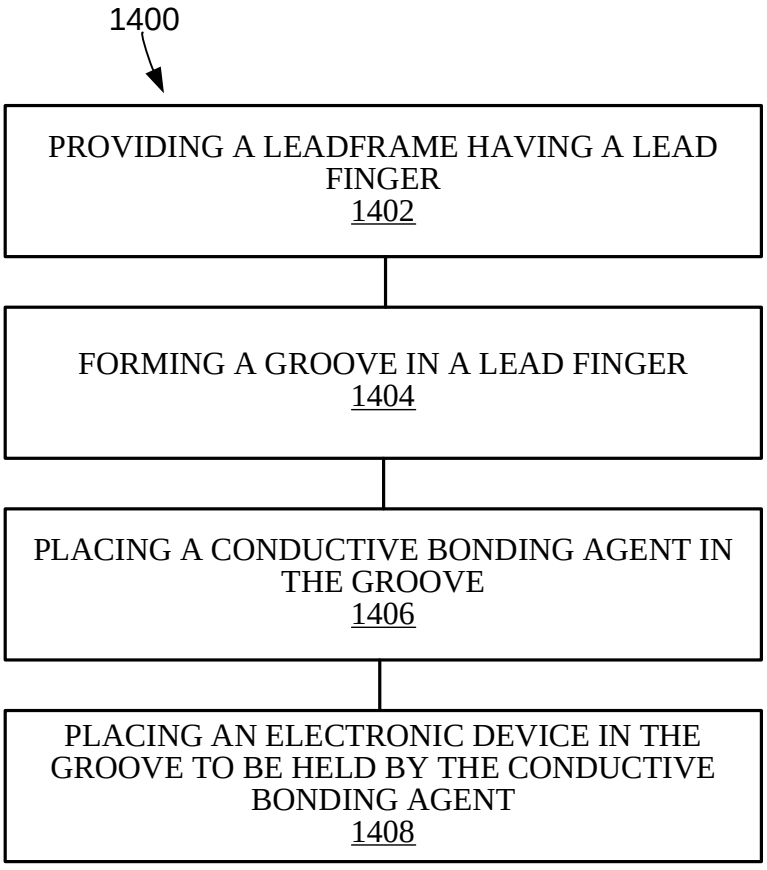

1400
PROVIDING A LEADFRAME HAVING A LEAD FINGER
1402
FORMING A GROOVE IN A LEAD FINGER
1404
PLACING A CONDUCTIVE BONDING AGENT IN THE GROOVE
1406
PLACING AN ELECTRONIC DEVICE IN THE GROOVE TO BE HELD BY THE CONDUCTIVE BONDING AGENT
1408

FIG. 14